

OFFICIAL DOCUMENT PACKAGE

Manufacturer's Manual

Amikon cover with selected official Siemens technical pages

SIEMENS SIMATIC S7-1500F

6ES7513-1FL02-0AB0

SIMATIC S7-1500F CPU 1513F-1 PN

Selected official pages retain the original technical tables, ratings, notes and pagination.

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Siemens datasheet 07/2018; System Manual A5E03461182-AN, 11/2025

Datasheet pages 1-11; system manual pages 183-184, 198-199, 222-223

This technical extract does not replace the complete equipment and system manuals. Check the installed hardware and project before use.

SIMATIC S7-1500F, CPU 1513F-1 PN, CENTRAL PROCESSING UNIT WITH WORKING MEMORY 450 KB FOR PROGRAM AND 1.5 MB FOR DATA, 1. INTERFACE: PROFINET IRT WITH 2 PORT SWITCH, 40 NS BIT-PERFORMANCE, SIMATIC MEMORY CARD NECESSARY



General information	
Product type designation	CPU 1513F-1 PN
HW functional status	FS01
Firmware version	V2.5
Engineering with	
STEP 7 TIA Portal configurable/integrated as of version	V15
Configuration control	
via dataset	Yes
Display	
Screen diagonal [cm]	3.45 cm
Control elements	
Number of keys	8
Mode buttons	2
Supply voltage	
Type of supply voltage	24 V DC
permissible range, lower limit (DC)	19.2 V

permissible range, upper limit (DC)	28.8 V
Reverse polarity protection	Yes
Mains buffering	
• Mains/voltage failure stored energy time	5 ms
• Repeat rate, min.	1 s
Input current	
Current consumption (rated value)	0.7 A
Current consumption, max.	0.95 A
Inrush current, max.	1.9 A; Rated value
I^2t	0.02 A ² ·s
Power	
Infeed power to the backplane bus	10 W
Power consumption from the backplane bus (balanced)	5.5 W
Power loss	
Power loss, typ.	5.7 W
Memory	
Number of slots for SIMATIC memory card	1
SIMATIC memory card required	Yes
Work memory	
• integrated (for program)	450 kbyte
• integrated (for data)	1.5 Mbyte
Load memory	
• Plug-in (SIMATIC Memory Card), max.	32 Gbyte
Backup	
• maintenance-free	Yes
CPU processing times	
for bit operations, typ.	40 ns
for word operations, typ.	48 ns
for fixed point arithmetic, typ.	64 ns
for floating point arithmetic, typ.	256 ns
CPU-blocks	
Number of elements (total)	2 000; Blocks (OB, FB, FC, DB) and UDTs
DB	
• Number range	1 ... 60 999; subdivided into: number range that can be used by the user: 1 ... 59 999, and number range of DBs created via SFC 86: 60 000 ... 60 999
• Size, max.	1.5 Mbyte; For non-optimized block accesses, the max. size of the DB is 64 KB
FB	
• Number range	0 ... 65 535

• Size, max.	450 kbyte
FC	
• Number range	0 ... 65 535
• Size, max.	450 kbyte
OB	
• Size, max.	450 kbyte
• Number of free cycle OBs	100
• Number of time alarm OBs	20
• Number of delay alarm OBs	20
• Number of cyclic interrupt OBs	20; With minimum OB 3x cycle of 500 µs
• Number of process alarm OBs	50
• Number of DPV1 alarm OBs	3
• Number of isochronous mode OBs	1
• Number of technology synchronous alarm OBs	2
• Number of startup OBs	100
• Number of asynchronous error OBs	4
• Number of synchronous error OBs	2
• Number of diagnostic alarm OBs	1
Nesting depth	
• per priority class	24; Up to 8 possible for F-blocks
Counters, timers and their retentivity	
S7 counter	
• Number	2 048
Retentivity	
— adjustable	Yes
IEC counter	
• Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
S7 times	
• Number	2 048
Retentivity	
— adjustable	Yes
IEC timer	
• Number	Any (only limited by the main memory)
Retentivity	
— adjustable	Yes
Data areas and their retentivity	
Retentive data area (incl. timers, counters, flags), max.	128 kbyte; In total; available retentive memory for bit memories, timers, counters, DBs, and technology data (axes): 88 KB

Extended retentive data area (incl. timers, counters, flags), max.	1.5 Mbyte; When using PS 60W 24/48/60V DC HF
Flag	
• Number, max.	16 kbyte
• Number of clock memories	8; 8 clock memory bit, grouped into one clock memory byte
Data blocks	
• Retentivity adjustable	Yes
• Retentivity preset	No
Local data	
• per priority class, max.	64 kbyte; max. 16 KB per block
Address area	
Number of IO modules	2 048; max. number of modules / submodules
I/O address area	
• Inputs	32 kbyte; All inputs are in the process image
• Outputs	32 kbyte; All outputs are in the process image
per integrated IO subsystem	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
per CM/CP	
— Inputs (volume)	8 kbyte
— Outputs (volume)	8 kbyte
Subprocess images	
• Number of subprocess images, max.	32
Hardware configuration	
Number of distributed IO systems	32; A distributed I/O system is characterized not only by the integration of distributed I/O via PROFINET or PROFIBUS communication modules, but also by the connection of I/O via AS-i master modules or links (e.g. IE/PB-Link)
Number of DP masters	
• Via CM	6; A maximum of 6 CMs (PROFINET + PROFIBUS) can be inserted in total
Number of IO Controllers	
• integrated	1
• Via CM	6; A maximum of 6 CMs (PROFINET + PROFIBUS) can be inserted in total
Rack	
• Modules per rack, max.	32; CPU + 31 modules
• Number of lines, max.	1
PtP CM	
• Number of PtP CMs	the number of connectable PtP CMs is only limited by the number of available slots
Time of day	

Clock	
• Type	Hardware clock
• Backup time	6 wk; At 40 °C ambient temperature, typically
• Deviation per day, max.	10 s; Typ.: 2 s
Operating hours counter	
• Number	16
Clock synchronization	
• supported	Yes
• in AS, master	Yes
• in AS, slave	Yes
• on Ethernet via NTP	Yes
Interfaces	
Number of PROFINET interfaces	1
1. Interface	
Interface types	
• Number of ports	2
• integrated switch	Yes
• RJ 45 (Ethernet)	Yes; X1
Protocols	
• IP protocol	Yes; IPv4
• PROFINET IO Controller	Yes
• PROFINET IO Device	Yes
• SIMATIC communication	Yes
• Open IE communication	Yes
• Web server	Yes
• Media redundancy	Yes; MRP Automanager according to IEC 62439-2 Edition 2.0
PROFINET IO Controller	
Services	
— PG/OP communication	Yes
— S7 routing	Yes
— Isochronous mode	Yes
— Open IE communication	Yes
— IRT	Yes
— MRP	Yes; As MRP redundancy manager and/or MRP client; max. number of devices in the ring: 50
— MRPD	Yes; Requirement: IRT
— PROFINergy	Yes
— Prioritized startup	Yes; Max. 32 PROFINET devices
— Number of connectable IO Devices, max.	128; In total, up to 512 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
— Of which IO devices with IRT, max.	64

— Number of connectable IO Devices for RT, max.	128
— of which in line, max.	128
— Number of IO Devices that can be simultaneously activated/deactivated, max.	8; in total across all interfaces
— Number of IO Devices per tool, max.	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Update time for IRT	
— for send cycle of 250 µs	250 µs to 4 ms; Note: In the case of IRT with isochronous mode, the minimum update time of 500 µs of the isochronous OB is decisive
— for send cycle of 500 µs	500 µs to 8 ms
— for send cycle of 1 ms	1 ms to 16 ms
— for send cycle of 2 ms	2 ms to 32 ms
— for send cycle of 4 ms	4 ms to 64 ms
— With IRT and parameterization of "odd" send cycles	Update time = set "odd" send clock (any multiple of 125 µs: 375 µs, 625 µs ... 3 875 µs)
Update time for RT	
— for send cycle of 250 µs	250 µs to 128 ms
— for send cycle of 500 µs	500 µs to 256 ms
— for send cycle of 1 ms	1 ms to 512 ms
— for send cycle of 2 ms	2 ms to 512 ms
— for send cycle of 4 ms	4 ms to 512 ms
PROFINET IO Device	
Services	
— PG/OP communication	Yes
— S7 routing	Yes
— Isochronous mode	No
— Open IE communication	Yes
— IRT	Yes
— MRP	Yes
— MRPD	Yes; Requirement: IRT
— PROFINergy	Yes
— Shared device	Yes
— Number of IO Controllers with shared device, max.	4
— Asset management record	Yes; Per user program
Interface types	
RJ 45 (Ethernet)	
• 100 Mbps	Yes

• Autonegotiation	Yes
• Autocrossing	Yes
• Industrial Ethernet status LED	Yes

Protocols

Number of connections	
• Number of connections, max.	128; via integrated interfaces of the CPU and connected CPs / CMs
• Number of connections reserved for ES/HMI/web	10
• Number of connections via integrated interfaces	88
• Number of S7 routing paths	16
PROFINET IO Controller	
Services	
— PG/OP communication	Yes
— S7 routing	Yes
— Isochronous mode	Yes
— Open IE communication	Yes
— IRT	Yes
— PROFINergy	Yes
— Prioritized startup	Yes; Max. 32 PROFINET devices
— Number of connectable IO Devices, max.	128; In total, up to 512 distributed I/O devices can be connected via AS-i, PROFIBUS or PROFINET
— Of which IO devices with IRT, max.	64
— Number of connectable IO Devices for RT, max.	128
— of which in line, max.	128
— Number of IO Devices that can be simultaneously activated/deactivated, max.	8; in total across all interfaces
— Number of IO Devices per tool, max.	8
— Updating times	The minimum value of the update time also depends on communication share set for PROFINET IO, on the number of IO devices, and on the quantity of configured user data
Redundancy mode	
— MRP	Yes; As MRP redundancy manager and/or MRP client; max. number of devices in the ring: 50
— MRPD	Yes; Requirement: IRT
SIMATIC communication	
• S7 communication, as server	Yes
• S7 communication, as client	Yes
• User data per job, max.	See online help (S7 communication, user data size)
Open IE communication	
• TCP/IP	Yes

— Data length, max.	64 kbyte
— several passive connections per port, supported	Yes
• ISO-on-TCP (RFC1006)	Yes
— Data length, max.	64 kbyte
• UDP	Yes
— Data length, max.	2 kbyte
— UDP multicast	Yes
• DHCP	No
• SNMP	Yes
• DCP	Yes
• LLDP	Yes
Web server	
• HTTP	Yes; Standard and user pages
• HTTPS	Yes; Standard and user pages
OPC UA	
• Runtime license required	Yes
• OPC UA Server	Yes; Data access (read, write, subscribe), method call, custom address space
— Application authentication	Yes
— Security policies	Available security policies: None, Basic128Rsa15, Basic256Rsa15, Basic256Sha256
— User authentication	"anonymous" or by user name & password
— Number of sessions, max.	32
— Number of accessible variables, max.	50 000
— Number of registerable nodes, max.	10 000
— Subscriptions per session, max.	20
— Sampling time, min.	100 ms
— Send time, min.	500 ms
— Number of server methods, max.	20
— Number of inputs/outputs per server method, max.	20
— Number of monitored items, max.	1 000; For 1 s sampling interval and 1 s send interval
— Number of server interfaces, max.	10
— Number of nodes for user-defined server interfaces, max.	1 000
Further protocols	
• MODBUS	Yes; MODBUS TCP
Media redundancy	
• Switchover time on line break, typ.	200 ms; For MRP, bumpless for MRPD
• Number of stations in the ring, max.	50
Isochronous mode	

Isochronous operation (application synchronized up to terminal)	Yes; With minimum OB 6x cycle of 500 µs
Equidistance	Yes
S7 message functions	
Number of login stations for message functions, max.	32
Program alarms	Yes
Number of configurable program alarms	5 000
Number of simultaneously active program alarms	
• Number of program alarms	300
• Number of alarms for system diagnostics	100
• Number of alarms for motion technology objects	80
Test commissioning functions	
Joint commission (Team Engineering)	Yes; Parallel online access possible for up to 5 engineering systems
Status block	Yes; Up to 8 simultaneously (in total across all ES clients)
Single step	No
Number of breakpoints	8
Status/control	
• Status/control variable	Yes
• Variables	Inputs/outputs, memory bits, DBs, distributed I/Os, timers, counters
• Number of variables, max.	
— of which status variables, max.	200; per job
— of which control variables, max.	200; per job
Forcing	
• Forcing, variables	Peripheral inputs/outputs
• Number of variables, max.	200
Diagnostic buffer	
• present	Yes
• Number of entries, max.	1 000
— of which powerfail-proof	500
Traces	
• Number of configurable Traces	4; Up to 512 KB of data per trace are possible
Interrupts/diagnostics/status information	
Diagnostics indication LED	
• RUN/STOP LED	Yes
• ERROR LED	Yes
• MAINT LED	Yes
• STOP ACTIVE LED	Yes
• Connection display LINK TX/RX	Yes

Supported technology objects

Motion Control • Number of available Motion Control resources for technology objects (except cam disks) • Required Motion Control resources — per speed-controlled axis — per positioning axis — per synchronous axis — per external encoder — per output cam — per cam track — per probe • Synchronized axes (relative gear synchronization) — Number of axes, max.	Yes; Note: The number of axes affects the cycle time of the PLC program; selection guide via the TIA Selection Tool or SIZER 800 40 80 160 80 20 160 40 3; Requirement: There must be no other motion technology objects created
Controller • PID_Compact • PID_3Step • PID-Temp	Yes; Universal PID controller with integrated optimization Yes; PID controller with integrated optimization for valves Yes; PID controller with integrated optimization for temperature
Counting and measuring • High-speed counter	Yes

Standards, approvals, certificates

Highest safety class achievable in safety mode	
• Performance level according to ISO 13849-1	PLe
• SIL acc. to IEC 61508	SIL 3
Probability of failure (for service life of 20 years and repair time of 100 hours)	
— Low demand mode: PFDavg in accordance with SIL3	< 2.00E-05
— High demand/continuous mode: PFH in accordance with SIL3	< 1.00E-09

Ambient conditions

Ambient temperature during operation	
• horizontal installation, min.	0 °C
• horizontal installation, max.	60 °C; Display: 50 °C, at an operating temperature of typically 50 °C, the display is switched off
• vertical installation, min.	0 °C
• vertical installation, max.	40 °C; Display: 40 °C, at an operating temperature of typically 40 °C, the display is switched off
Ambient temperature during storage/transportation	
• min.	-40 °C

- max.

70 °C

Configuration

Programming

Programming language

— LAD	Yes; incl. failsafe
— FBD	Yes; incl. failsafe
— STL	Yes
— SCL	Yes
— GRAPH	Yes

Know-how protection

• User program protection/password protection	Yes
• Copy protection	Yes
• Block protection	Yes

Access protection

• Password for display	Yes
• Protection level: Write protection	Yes; Specific write protection both for Standard and for Failsafe
• Protection level: Read/write protection	Yes
• Protection level: Complete protection	Yes

Cycle time monitoring

• lower limit	adjustable minimum cycle time
• upper limit	adjustable maximum cycle time

Dimensions

Width	35 mm
Height	147 mm
Depth	129 mm

Weights

Weight, approx.	405 g
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last modified: 07/16/2018

Installation

7.1 Basics

Introduction

All modules of the S7-1500 automation system/ET 200MP distributed I/O system are open equipment. This means that you may only install this system in housings, cabinets or electrical operating rooms that are located indoors. The housings, cabinets and electrical operating rooms must guarantee protection against electric shock and spread of fire. The requirements for mechanical strength must also be met. The housings, cabinets, and electrical operating rooms must not be accessible without a key or tool. Personnel with access must have been trained or authorized.

Installation position

The S7-1500 automation system / ET 200MP distributed I/O system is designed for the following mounting positions:

- Horizontal mounting position for ambient temperatures up to 60 °C
- Vertical mounting position (CPU is down) for ambient temperatures up to 40 °C

More information can be found in chapter Mechanical and climatic ambient conditions [\(Page 427\)](#).

Mounting rail

You can mount the following components on the mounting rails alongside the S7-1500/ET 200MP modules:

- Modules from the S7-1200 and ET 200SP range
- Terminals
- Circuit breakers
- Small contactors
- Similar components

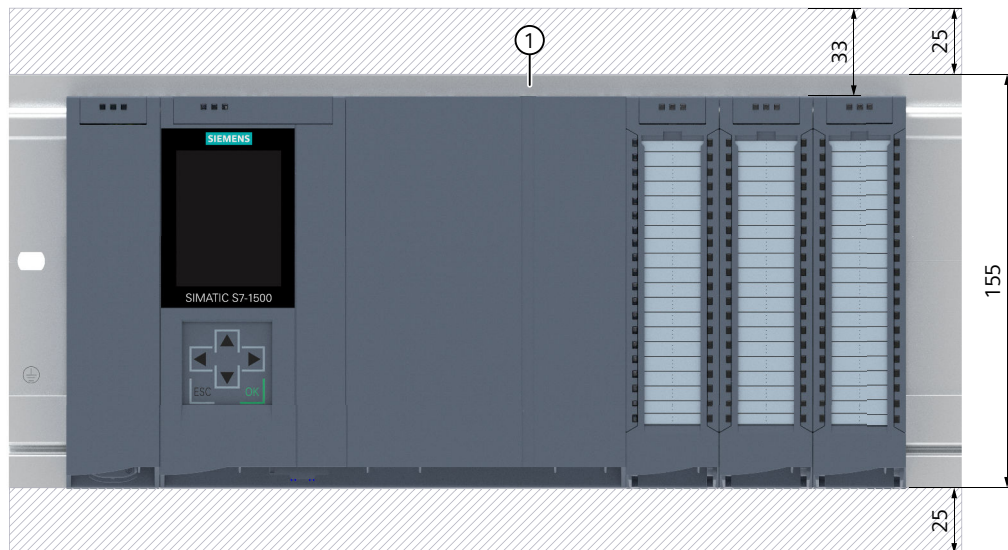
These components can influence the installation dimensions for the cable duct.

Modules can be mounted right to the outer edge of the mounting rail.

The mounting rails are available in various lengths. You order the mounting rails using the online catalog or the online ordering system. You can find the available lengths and article numbers in the section Accessories/spare parts [\(Page 438\)](#).

Minimum clearances

The modules can be mounted to the outer edge of the mounting rail. Maintain the following minimum clearances at the top and bottom when installing or removing the S7-1500 automation system / ET 200MP distributed I/O system:



① Upper edge of the mounting rail

Figure 7-1 Minimum clearances in the control cabinet

Installation rules

- The installation starts on the left with a CPU/interface module or a system power supply/load current supply.
- You connect the modules to each other with U connectors.
- Note that no U connector protrudes from the first and last module.

NOTE

Only remove and insert modules when the power to the system is switched off.

WARNING

Protection from conductive contamination

Protect the devices against conductive contamination. At the same time, note the ambient conditions.

Protection from conductive contamination can, for example, be achieved by installing the devices in a control cabinet with the appropriate degree of protection.

7.6 Installing the CPU

Introduction

The CPU executes the user program and supplies the electronics of the modules with power via the backplane bus.

Requirements

The mounting rail is installed.

In a system power supply located on the left next to the CPU, a U connector is inserted on the back right.

NOTE

Protective film

Please note that the CPU is supplied with a removable protective film on the display. You can remove the protective film as required.

Tools required

Screwdriver with 4.5 mm blade

Installing the CPU

Watch video sequence (<https://support.industry.siemens.com/cs/ww/en/view/78027451>)

To install a CPU, follow these steps:

1. Insert a U-connector into the back right on the CPU.
2. Install the CPU to the mounting rail. Also push the CPU to the left system power supply if necessary.
3. Ensure that the U-connector is inserted at the system power supply. Swivel the CPU in to the rear.
4. Screw the CPU tight (tightening torque 1.5 Nm).



Figure 7-11 Installing the CPU

Uninstalling the CPU

The CPU is wired, and is followed by additional modules.

To uninstall a CPU, follow these steps:

1. Open the front cover.
2. Switch the CPU into STOP mode.
3. Turn off the feed supply voltage.
4. Pull off the connector for the supply voltage.
5. Loosen the bus connectors for PROFIBUS/PROFINET with the screwdriver.
6. Disconnect the bus connector from the CPU.
7. Undo the CPU fixing screws.
8. Pivot the CPU out of the mounting rail.

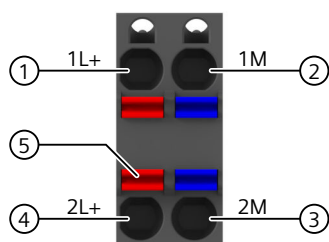
8.6 Connecting the supply voltage

Introduction

The supply voltage of the CPU/interface module is supplied by means of a 4-pole connection plug, which is located on the front or below on the CPU / interface module.

Connection for supply voltage (X80)

The connections of the 4-pole connector have the following meaning:



- ① +24 V DC of the supply voltage (current limited to 10 A)
- ② Ground of the supply voltage (current limited to 10 A)
- ③ Ground of the supply voltage for loop-through
- ④ +24 V DC of the supply voltage for loop-through
- ⑤ Spring opener (one spring opener per terminal)

Figure 8-5 Connection for supply voltage

The cable connector offers you the option of looping the supply voltage uninterrupted, even when it is unplugged.

For the maximum wire cross-sections, observe the information in the tables of the Wiring rules [\(Page 217\)](#).

Requirements

- Only wire the cable connector when the supply voltage is turned off.
- Observe the Wiring rules [\(Page 217\)](#).

Tools required

3 to 3.5 mm screwdriver

Tool-free connection of cables: multi-wire (stranded), with end sleeve or ultrasonic compressed

To connect a wire without tools, follow these steps:

1. Strip 8 to 11 mm of the wires.
2. Seal or crimp the wire with end sleeves.
3. Insert the wire into the push-in terminal as far as it will go.
4. Push the wired connector into the socket of the CPU/interface module.

Connection of wires: multi-wire (stranded), without end sleeve, unprocessed

To connect a wire without end sleeve, follow these steps:

1. Strip 8 to 11 mm of the wires.
2. Using a screwdriver, press the spring release and insert the wire into the push-in terminal as far as it will go.
3. Pull the screwdriver out of the spring release.
4. Push the wired connector into the socket of the CPU/interface module.

Loosening a wire

Push with the screwdriver as far as it will go into the spring release. Remove the wire from the push-in terminal.

Uninstalling the connection plug

To uninstall the connection plug, you need a screwdriver. With the screwdriver, pry the connection plug out of the CPU/interface module.